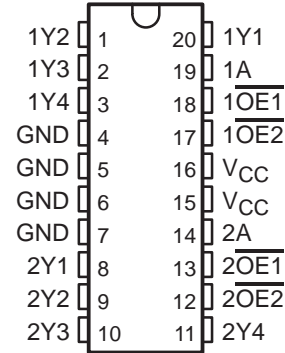


- Low-Skew Propagation Delay Specifications for Clock-Driver Applications
- TTL-Compatible Inputs and CMOS-Compatible Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1- μ m Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline (DW)

DW PACKAGE
(TOP VIEW)



description

The CDC208 contains dual clock-driver circuits that fanout one input signal to four outputs with minimum skew for clock distribution (see Figure 2). The device also offers two output-enable ($\overline{OE1}$ and $\overline{OE2}$) inputs for each circuit that can force the outputs to be disabled to a high-impedance state or to a high- or low-logic level independent of the signal on the respective A input.

Skew parameters are specified for a reduced temperature and voltage range common to many applications.

The CDC208 is characterized for operation from –40°C to 85°C.

FUNCTION TABLES

INPUTS			OUTPUTS			
$\overline{1OE1}$	$\overline{1OE2}$	1A	1Y1	1Y2	1Y3	1Y4
L	L	L	L	L	L	L
L	L	H	H	H	H	H
L	H	X	L	L	L	L
H	L	X	H	H	H	H
H	H	X	Z	Z	Z	Z

INPUTS			OUTPUTS			
$\overline{2OE1}$	$\overline{2OE2}$	2A	2Y1	2Y2	2Y3	2Y4
L	L	L	L	L	L	L
L	L	H	H	H	H	H
L	H	X	L	L	L	L
H	L	X	H	H	H	H
H	H	X	Z	Z	Z	Z



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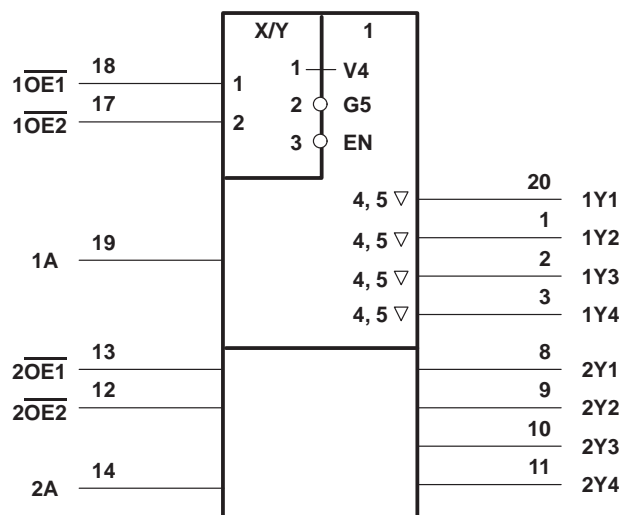
CDC208

DUAL 1-LINE TO 4-LINE CLOCK DRIVER

WITH 3-STATE OUTPUTS

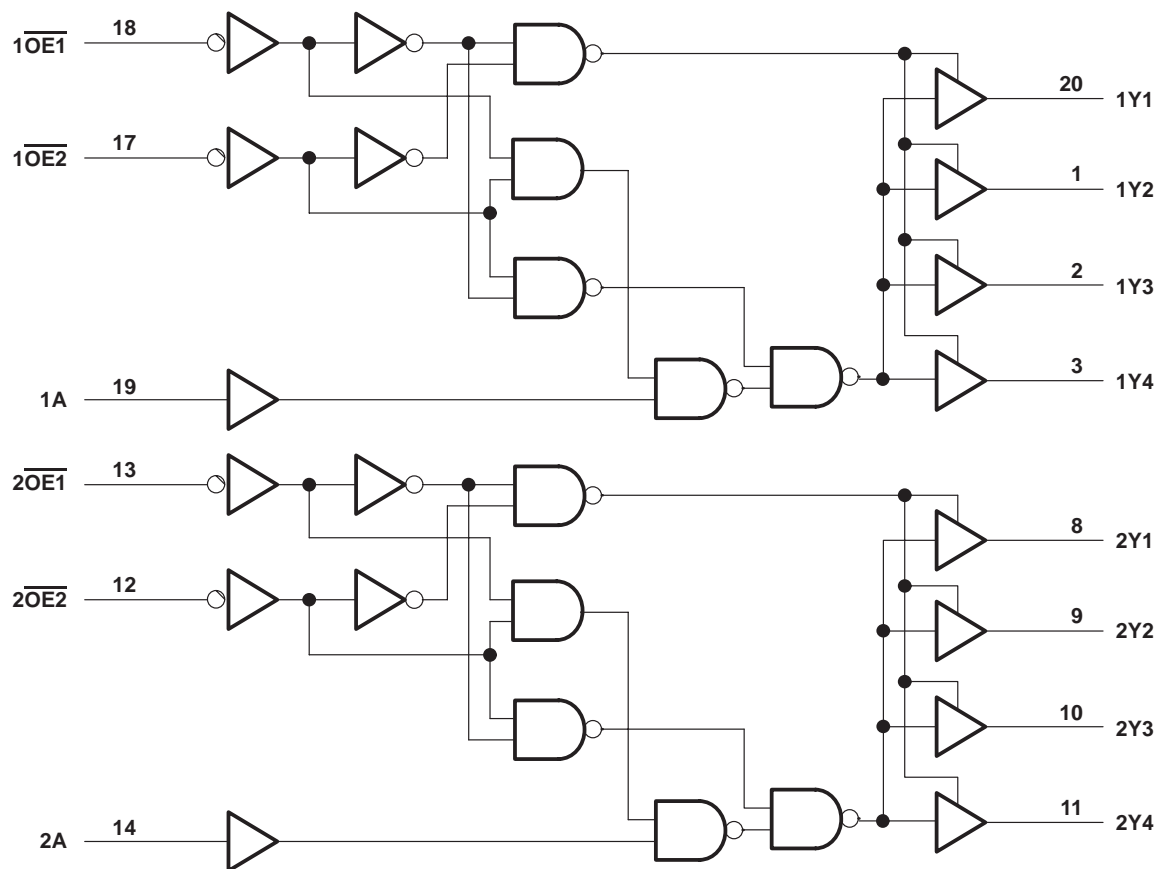
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



CDC208

DUAL 1-LINE TO 4-LINE CLOCK DRIVER WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V_{CC} or GND	±200 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2)	1.6 W
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.
 For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

recommended operating conditions

	MIN	NOM	MAX	UNIT
V_{CC} Supply voltage	4.5	5	5.5	V
V_{IH} High-level input voltage	2			V
V_{IL} Low-level input voltage			0.8	V
V_I Input voltage	0	V_{CC}		V
I_{OH} High-level output current			–24	mA
I_{OL} Low-level output current			24	mA
$\Delta t / \Delta v$ Input transition rise or fall rate	0		10	ns/V
f_{clock} Input clock frequency			60	MHz
T_A Operating free-air temperature	–40		85	°C



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WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
V _{OH}	I _{OH} = −50 μA	4.5 V	4.4			4.4		V
		5.5 V	5.4			5.4		
	I _{OH} = −24 mA	4.5 V	3.94			3.8		
		5.5 V	4.94			4.8		
	I _{OH} = −75 mA†	5.5 V				3.85		
V _{OL}	I _{OL} = 50 μA	4.5 V	0.1			0.1		V
		5.5 V	0.1			0.1		
	I _{OL} = 24 mA	4.5 V	0.36			0.44		
		5.5 V	0.36			0.44		
	I _{OL} = 75 mA†	5.5 V				1.65		
I _I	V _I = V _{CC} or GND	5.5 V	±0.1			±1		μA
I _{OZ}	V _O = V _{CC} or GND	5.5 V	±0.5			±5		μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V	8			80		μA
ΔI _{CC} ‡	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V	0.9			1		mA
C _i	V _I = V _{CC} or GND	5 V	4					pF
C _o	V _O = V _{CC} or GND	5 V	10					pF

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

‡ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

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DUAL 1-LINE TO 4-LINE CLOCK DRIVER
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**switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
t_{PLH}	1A and 2A	Any Y	5.3	8.5	10.9	5.3	11.7	ns
t_{PHL}			3.6	7.7	11	3.6	11.5	
t_{PLH}	$\overline{1OE1}$, $\overline{1OE2}$, and $\overline{2OE1}$, $\overline{2OE2}$	Any Y	4.7	8.5	11.7	4.7	12.8	ns
t_{PHL}			4.4	8.4	11.3	4.4	12.4	
t_{PZH}	$\overline{1OE2}$ or $\overline{2OE2}$	Any Y	4.4	8.1	11.3	4.4	12.4	ns
t_{PZL}	$\overline{1OE1}$ or $\overline{2OE1}$		5	9.6	13.3	5	14.9	
t_{PHZ}	$\overline{1OE2}$ or $\overline{2OE2}$	Any Y	4.2	7.4	9.3	4.2	10.2	ns
t_{PLZ}	$\overline{1OE1}$ or $\overline{2OE1}$		5.4	7.5	9.2	5.4	9.9	

switching characteristics, $V_{CC} = 5\text{ V} \pm 0.25\text{ V}$, $T_A = 25^\circ\text{C}$ to 70°C (see Note 3 and Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
t_{PLH}	1A and 2A	Any Y	6.6	10.2	ns
t_{PHL}			6.6	9.8	
$t_{sk(o)}$	1A and 2A	Any Y		1	ns

NOTE 3: All specifications are valid only for all outputs switching simultaneously and in phase.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance per bank	Outputs enabled	$C_L = 50\text{ pF}$, $f = 1\text{ MHz}$	96	pF
		Outputs disabled		12	

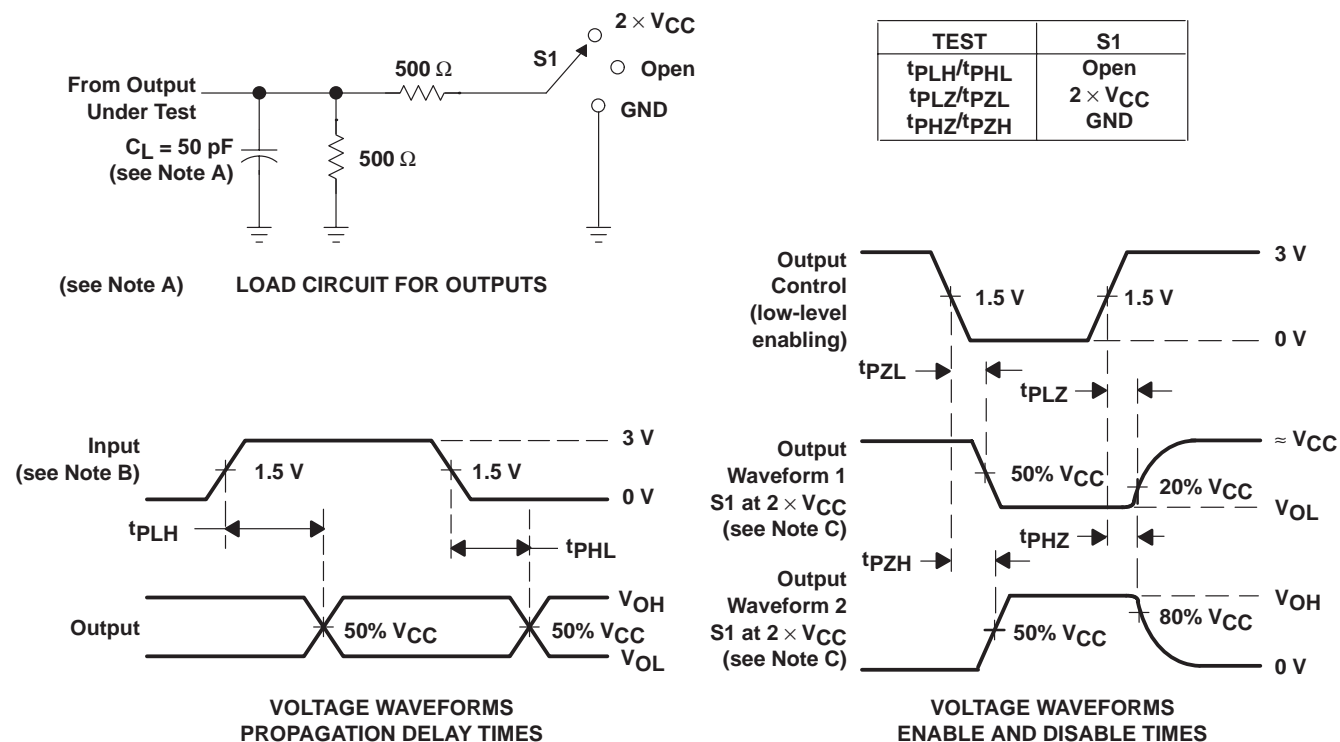
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DUAL 1-LINE TO 4-LINE CLOCK DRIVER

WITH 3-STATE OUTPUTS

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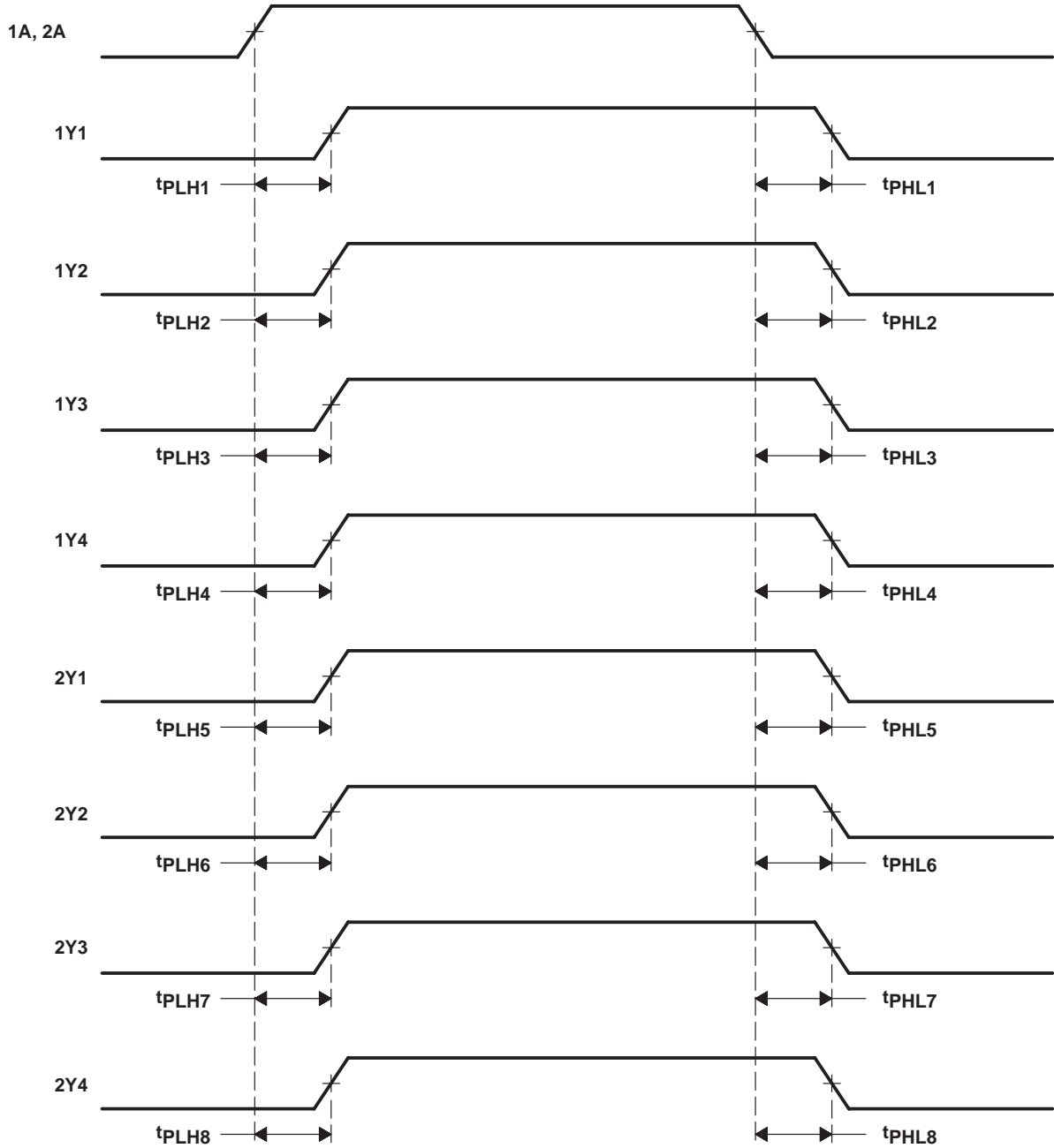
PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 3 \text{ ns}$, $t_f \leq 3 \text{ ns}$. For testing pulse duration: $t_r = t_f = 1 \text{ to } 3 \text{ ns}$. Pulse polarity can be either high-to-low-to-high or low-to-high-to-low.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTE A: Output skew, $t_{sk(o)}$, is calculated as the greater of:

- The difference between the fastest and slowest of t_{PLHn} ($n = 1, 2, \dots, 8$)
- The difference between the fastest and slowest of t_{PHLn} ($n = 1, 2, \dots, 8$)

Figure 2. Waveforms for Calculation of $t_{sk(o)}$

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DUAL 1-LINE TO 4-LINE CLOCK DRIVER
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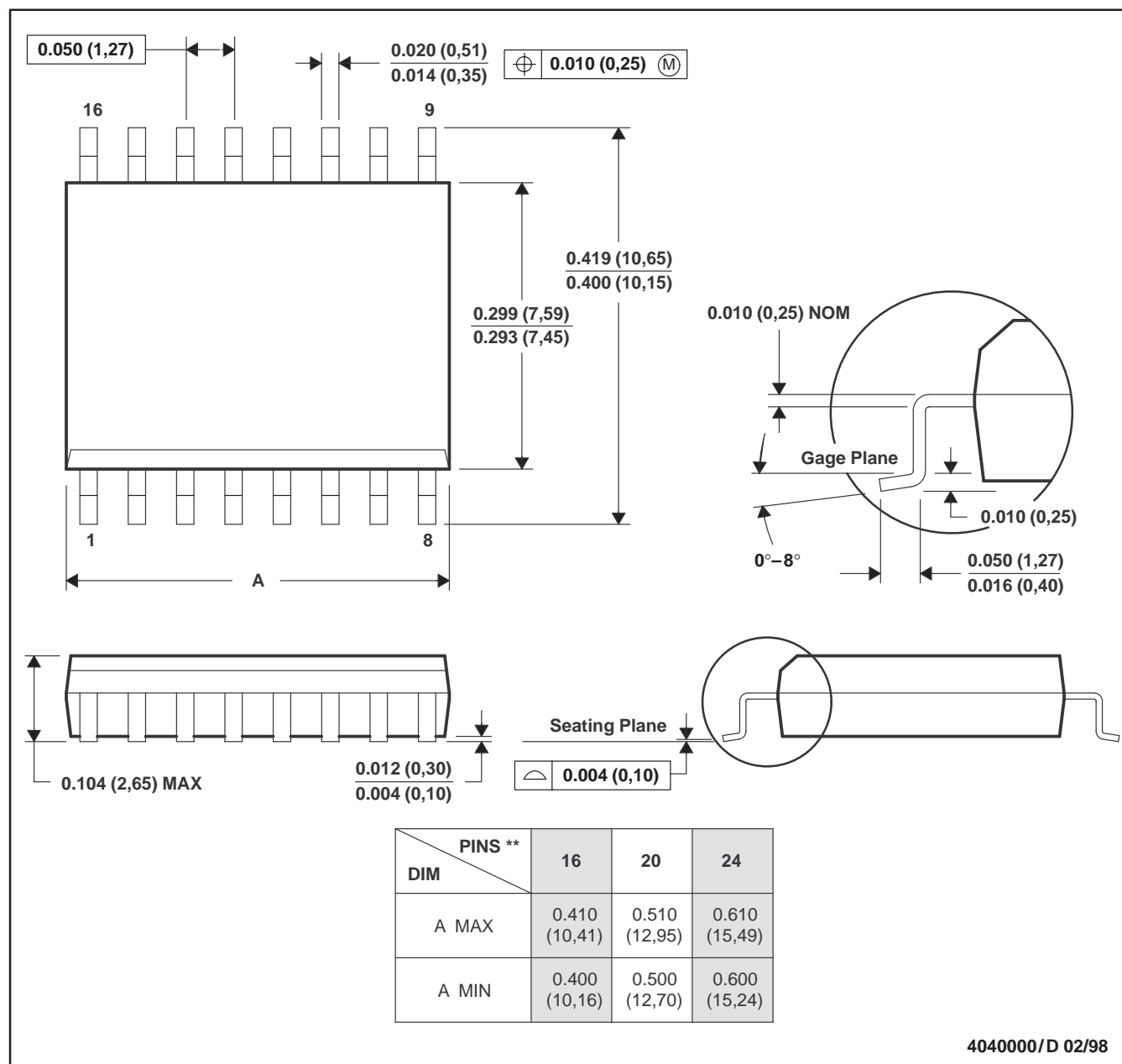
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MECHANICAL INFORMATION

DW (R-PDSO-G)**

PLASTIC SMALL-OUTLINE PACKAGE

16 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CDC208DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
CDC208DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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